| ASSOCIATION CONNECTING<br>ELECTRONICS INDUSTRIES® International and | <b>nposition De</b><br>5. IPC, Bannockl<br>Pan-American co     | <b>claration</b><br>ourn, Illinois. A<br>opyright conve | Il rights reserved u ntions. | nder both       | This docume<br>level parts, t   | ent is a declarati<br>he declaration e | on of the substancompasses all | nces within the ma<br>lower level materia | nufacturer list<br>ls for which th | ed item. Note: i<br>ne manufacture | if the item is an as<br>r has engineering | ssembly with low responsibility. |  |
|---|--|---|------------------------------|-----------------|---|--|--------------------------------|---|------------------------------------|------------------------------------|---|----------------------------------|--|
|   | 1 IPC Web Site for Information on IPC-1752 Standard Form Distr |   |                              |                 | n Type * Declaration Class *<br>ribute Class 6 - RoHS Yes/No, Homogeneous Mater |  |                                |   | Materials and                      | ials and Mfg Information           |   |                                  |  |
| upplier Information   |  |   |                              |                 |   |  |                                |   |                                    |                                    |   |                                  |  |
| ompany name*  | Company unique ID  |   |                              | 1               | Unique ID Authority   |  |                                |   | Response Date*                     |                                    |   |                                  |  |
| onsemi  |  |   |                              |                 |   |  |                                |   |                                    | 2023-06-08                         |   |                                  |  |
| Contact Name Title  |  |   | Title - Contact              |                 |   | Phone - Contact*                       |                                |   | Ema                                | Email - Contact*                   |   |                                  |  |
| Product-Env-Stewards P.   |  |   | Product Enviro Compliance    |                 |   | NA                                     |                                |   | Pro                                | Product-Env-Stewards@onsemi.com    |   |                                  |  |
| Authorized Representative* Title                                    |  |   | Title - Representative       |                 |   | Phone - Representative*                |                                |   | Ema                                | Email - Representative*            |   |                                  |  |
| Product-Env-Stewards Pro  |  |   | Product Enviro Compliance    |                 |   | NA                                     |                                |   | Pro                                | Product-Env-Stewards@onsemi.com    |   |                                  |  |
| Requester Item Number   | Mfr Iten   | n Number  | Mfr Item Name                |                 |   | Effective Date                         | Version                        | Manufacturing                             | Site                               | Weight*                            | UOM                                       | Unit Type                        |  |
|   | MC79L0   | MC79L05ACPRAG ANA 100MA                                 |                              | 5V NEGATIV VREG |   | 2023-06-08                             |                                | CNF                                       | CNF                                |                                    | mg  | Each                             |  |
| Ianufacturing Proccess Inform                                       | nation   |   |                              |                 |   |  |                                |   |                                    |                                    |   |                                  |  |
| Terminal Plating / Grid Array                                       | Terminal Plating / Grid Array Material Terminal Base           |   | Alloy J-STD-020 MSL Ratir    |                 | L Rating  | Peak Process Body Temperature Max Tir  |                                | erature Max Time                          | at Peak Temp                       | erature Numb                       | per of Reflow Cy                          | cles                             |  |
| Matte Tin (Sn) - annealed   |  | CU Alloy NA   |                              |                 | 0 C   |  | 30                             | se  | conds 3                            |                                    |   |                                  |  |
| omments   |  |   |                              |                 |   |  |                                |   |                                    |                                    |   |                                  |  |
|   |  |   |                              |                 |   |  |                                |   |                                    |                                    |   |                                  |  |
| or more information regarding mater                                 | rial composition   | please refer to   | page 3                       |                 |   |  |                                |   |                                    |                                    |   |                                  |  |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |
|--|---|--|---|---|---|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the  | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa   | on above   | Supplier Acceptance   | * Accepted                                      |   |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per  | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |  |  |  |  |  |
| Declaration Signature  |   |  |   |   |   |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester   | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska   | Le   |   |   |   |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance                  | CAS              | Exempt | Weight  | Unit of Measure |
|----------------------|--------|-----------------|----------|----------------------------|------------------|--------|---------|-----------------|
| Die                  | 3.2    | mg              | Supplier | Silicon (Si)               | 7440-21-3        |        | 3.2     | mg              |
| Die Attach           | 5.15   | mg              | Supplier | Silver (Ag)                | 7440-22-4        |        | 4.3775  | mg              |
|                      |        |                 | Supplier | Phenolic Resin             | Proprietary Data |        | 0.7725  | mg              |
| Lead Frame           | 80.67  | mg              | Supplier | Silver (Ag)                | 7440-22-4        |        | 0.0081  | mg              |
|                      |        |                 | Supplier | Iron (Fe)                  | 7439-89-6        |        | 0.0807  | mg              |
|                      |        |                 | Supplier | Copper (Cu)                | 7440-50-8        |        | 80.5571 | mg              |
|                      |        |                 | Supplier | Phosphorus (P)             | 7723-14-0        |        | 0.0242  | mg              |
| Mold Compound-Black  | 106.15 | mg              |          | Phenol Resin               | proprietary data |        | 10.615  | mg              |
|                      |        |                 | Supplier | Carbon Black (C)           | 1333-86-4        |        | 1.0615  | mg              |
|                      |        |                 | Supplier | Fused Silica (SiO2)        | 60676-86-0       |        | 81.7355 | mg              |
|                      |        |                 | Supplier | Ortho-Cresol Novolac Resin | 29690-82-2       |        | 12.738  | mg              |
| Plating              | 2.74   | mg              | Supplier | Tin (Sn)                   | 7440-31-5        |        | 2.74    | mg              |
| Wire Bond - Au       | 0.1    | mg              | Supplier | Gold (Au)                  | 7440-57-5        |        | 0.1     | mg              |